

#### **MOSFET TOLL**

## OptiMOS™ 5 Power-Transistor, 100 V

### **Features**

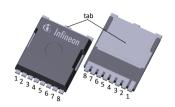
- Ideal for high frequency switching and sync. rec.
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
- Very low on-resistance R<sub>DS(on)</sub>
   N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

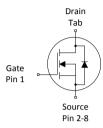
## **Product validation**

Qualified for industrial applications according to the relevant tests of JEDEC JESD47, JESD22 and J-STD-020.

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{ m DS}$	100	V
$R_{\mathrm{DS(on),max}}$	2.0	mΩ
$I_{D}$	260	A
$Q_{\rm oss}$	155	nC
Q <sub>G</sub> (0V10V)	122	nC







RoHS	
	ì

Part number	Package	Marking	Related links
IPT020N10N5	PG-HSOF-8	020N10N5	-

## Public

# OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



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# OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



## 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Comple	Values			Linit	Note / Test on divine
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition
				260		V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C
Continuous drain current <sup>1)</sup>	$I_{D}$	-	-	184	Α	V <sub>GS</sub> =10 V, T <sub>C</sub> =100 °C
				31		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1039	Α	T <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	406	-	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	$V_{\rm GS}$	-20	-	20	-	-
Power dissipation	$P_{\rm tot}$	-	-	273	W	<i>T</i> <sub>c</sub> =25 °C
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Symbol	Values			Unit	Note / Test condition
Parameter	Symbol Min. Typ. Max.	Max.				
Thermal resistance, junction - case	$R_{thJC}$		0.33	0.55		
Device on PCB, minimal footprint	$R_{thJA}$	-	-	62	°C/W	-
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{ m thJA}$		-	40		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Linit	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.		Note / Test condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 202 \mu{\rm A}$	
Zero gate voltage drain current	,	-	0.1	1	μΑ	$V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
	I <sub>DSS</sub>		10	100	μΑ	$V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	$I_{\rm GSS}$	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	D		1.6	2.0	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =150 A	
Diain-source on-state resistance	$R_{\rm DS(on)}$	_	2.0	2.7	11122	$V_{\rm GS}$ =6 V, $I_{\rm D}$ =75 A	
Gate resistance <sup>6)</sup>	R <sub>G</sub>	-	1.2	1.8	Ω	-	
Transconductance	$g_{fs}$	120	240	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 100 \text{ A}$	

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
Parameter	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance <sup>7)</sup>	C <sub>iss</sub>		8700	11000		
Output capacitance 7)	C <sub>oss</sub>	-	1300	1700	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =50 V, $f$ =1 MHz
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>		58	100		
Turn-on delay time	$t_{\sf d(on)}$		20			
Rise time	t <sub>r</sub>	<b>-</b>   -	13		nc	$V_{\rm DD} = 50 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A},$ $R_{\rm G,ext} = 1.8 \Omega$
Turn-off delay time	$t_{\sf d(off)}$		49	]-	ns	
Fall time	t <sub>f</sub>		17	]		

<sup>&</sup>lt;sup>7)</sup> Defined by design. Not subject to production test.

# OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



Table 6 Gate charge characteristics 8)

Parameter	Symbol		Values			Note / Test condition
rarameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition
Gate to source charge	$Q_{ m gs}$		39	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$		26	-	nC	
Gate to drain charge <sup>9)</sup>	$Q_{\mathrm{gd}}$		25	37	nC	
Switching charge	$Q_{sw}$	$\frac{1}{38}$ - $\frac{1}{100}$ - $\frac{1}{100}$	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V			
Gate charge total <sup>9)</sup>	$Q_{ m g}$		122	152	nC	
Gate plateau voltage	$V_{ m plateau}$		4.5	-	V	
Gate charge total, sync. FET	$Q_{\mathrm{g(sync)}}$	-	106	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge 8)	$Q_{\rm oss}$	-	155	207	nC	V <sub>DS</sub> =50 V, V <sub>GS</sub> =0 V

 $<sup>^{8)}~~{\</sup>rm See}$  "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

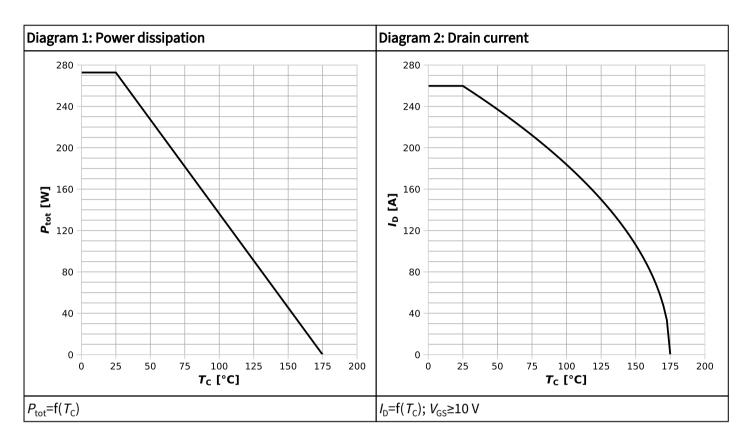
Parameter	Symbol	Values			l lnit	Note / Test condition	
raiametei	Min. Typ. Max.		Oilit	Note / Test condition			
Diode continuous forward current	$I_{\rm S}$			198	Α	<i>T<sub>c</sub></i> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	_	_	1039	Α	1 <sub>C</sub> -25 C	
Diode forward voltage	$V_{\rm SD}$	-	0.86	1.2	٧	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>10)</sup>	$t_{rr}$		56	112	ns	$V_{\rm p}$ =50 V, $I_{\rm p}$ =100 A, d $i_{\rm p}$ /d $t$ =100 A/ $\mu$ s	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	96	192	nC	ν <sub>R</sub> -30 ν, ι <sub>F</sub> -100 A, αι <sub>F</sub> /αι-100 A/μ5	

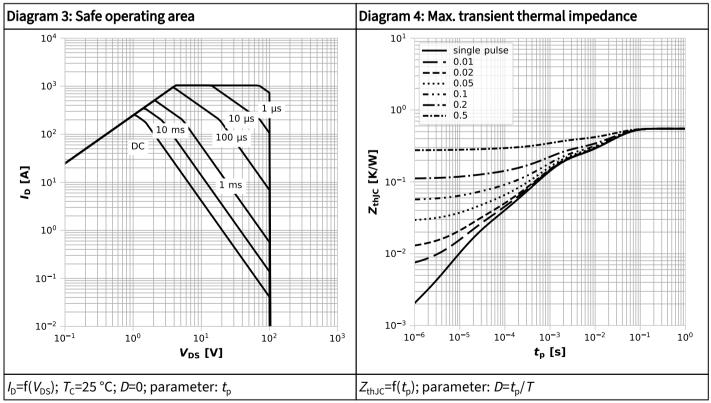
<sup>&</sup>lt;sup>10)</sup> Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

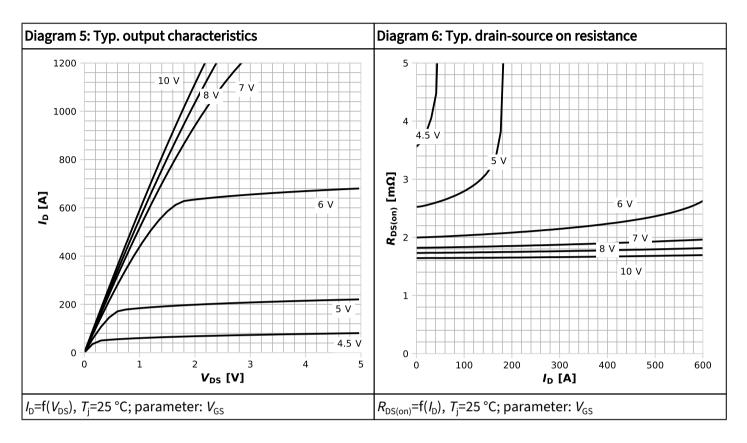


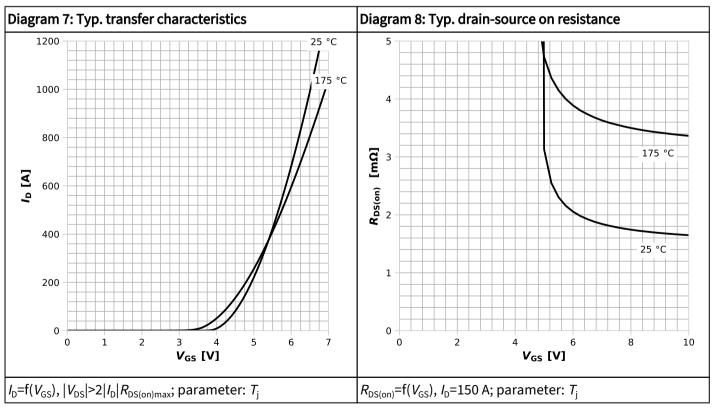
## 4 Electrical characteristics diagrams



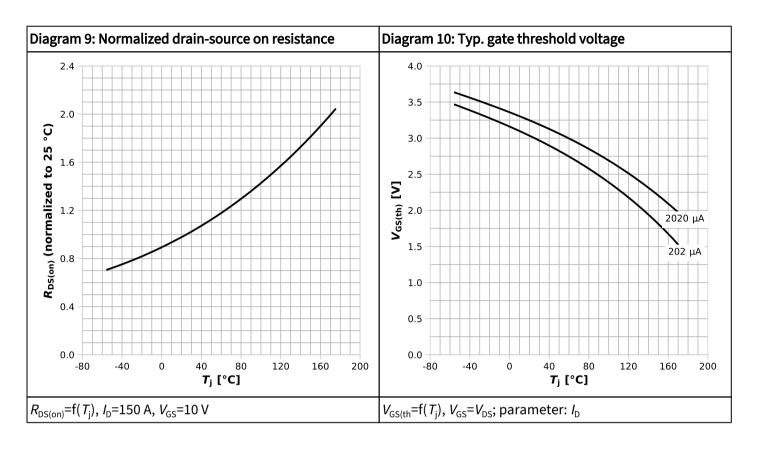


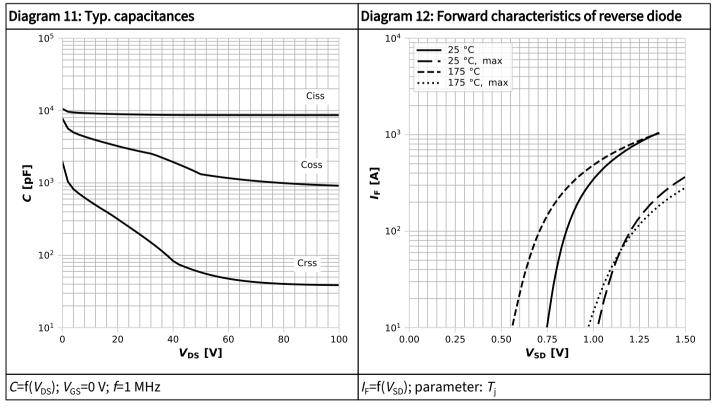




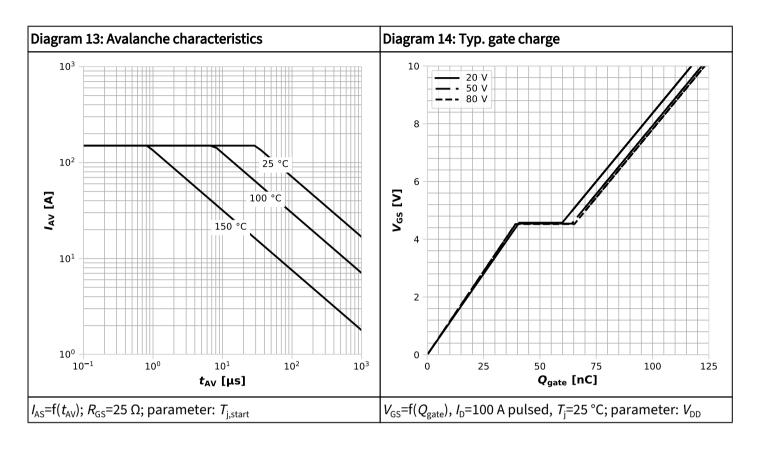


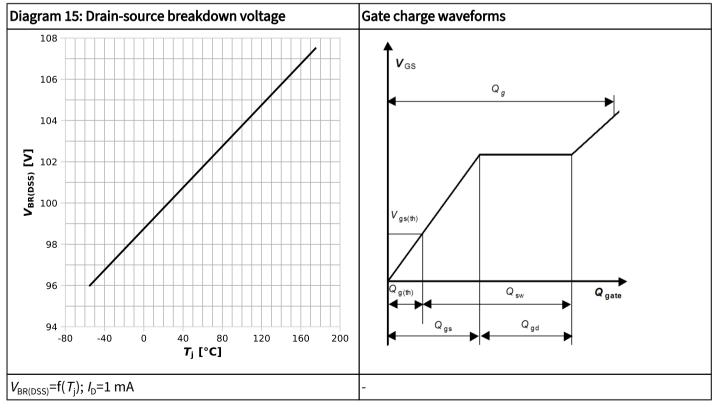






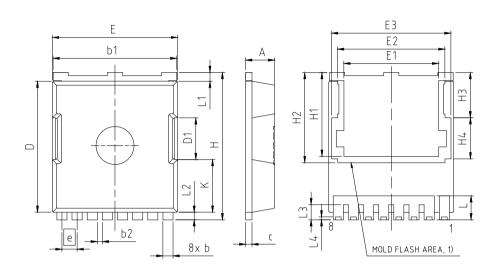




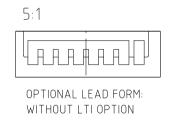




# 5 Package outlines



PACKAGE - GROUP NUMBER:	PG-HSOF-8-U01						
DIMENSIONS	MILLIM	IETERS					
DIMENSIONS	MIN.	MAX.					
Α	2.20	2.40					
b	0.70	0.90					
b1	9.70	9.90					
b2	0.42	0.50					
С	0.40	0.60					
D	10.28	10.58					
D1	3.30						
E	9.70	10.10					
E1	7.50						
E2	8.50						
E3	9.46						
е	1.20 (BSC)						
Н	11.48	11.88					
H1	6.55	6.95					
H2	7.	15					
Н3	3.	59					
H4	3.	26					
N	8						
K	4.18						
L	1.60	2.10					
L1	0.50	0.90					
L2	0.50	0.70					
L3	1.00	1.30					
L4	0.13	0.33					



1) PATIALLY COVERED WITH MOLD FLASH

Figure 1 Outline PG-HSOF-8, dimensions in mm



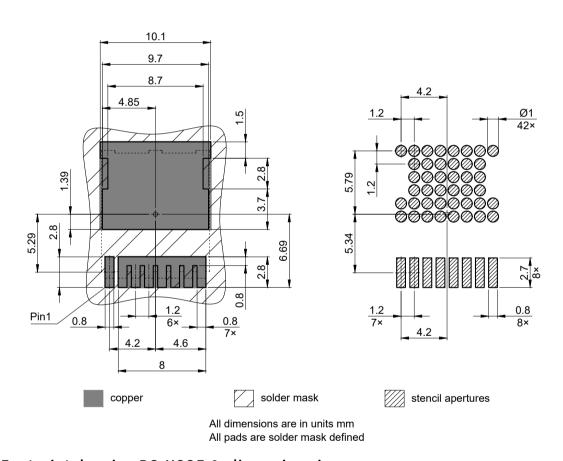


Figure 2 Footprint drawing PG-HSOF-8, dimensions in mm



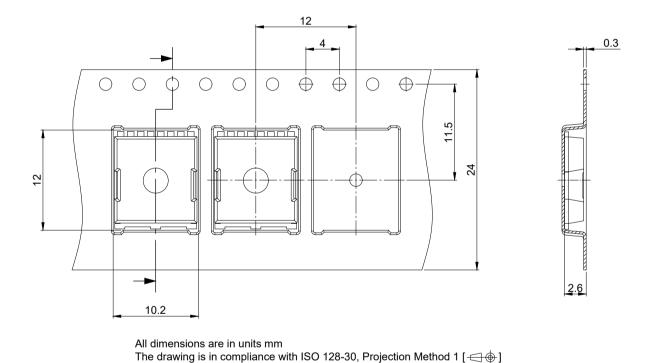


Figure 3 Packaging variant PG-HSOF-8, dimensions in mm

## Public

# OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



## **Revision history**

IPT020N10N5

## Revision 2025-06-02, Rev. 2.1

Previous revisions

Revision	Date	Subjects (major changes since last revision)
2.0	2019-03-26	Release of final version
2.1	2025-06-02	Update IDSS 100V max limit

#### **Public**

## OptiMOS™ 5 Power-Transistor, 100 V IPT020N10N5



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